

• General Description

It combines advanced trench MOSFET technology with a low resistance package to provide extremely low  $R_{DS(ON)}$ . It is suitable for automotive application.

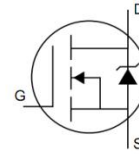
• Features

- AEC-Q101 Qualified
- Low  $R_{DS(ON)}$  to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

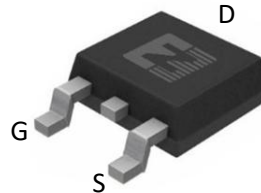
• Application

- BLDC Motor driver
- DC-DC
- Battery protection

• Product Summary



$V_{DS} = 100V$   
 $R_{DS(ON)} = 25m\Omega$   
 $I_D = 30A$



TO-252



• Ordering Information:

Part NO.	ZMSA250N10D
Marking	ZMS250N10
Packing Information	REEL TAPE
Basic ordering unit (pcs)	2500

• Absolute Maximum Ratings ( $T_C=25^\circ C$ )

Parameter	Symbol	Conditions	Value	Unit
Drain-Source Voltage	$V_{DS}$		100	V
Gate-Source Voltage <sup>①</sup>	$V_{GS}$		$\pm 20$	V
Continuous Drain Current	$I_D$	$T_C=25^\circ C$	30	A
	$I_D$	$T_C=75^\circ C$	24	A
	$I_D$	$T_C=100^\circ C$	21	A
Pulsed Drain Current	$I_{DM}$	Pulsed; $t_p \leq 10 \mu s$ ; $T_{mb} = 25^\circ C$ ;	90	A
Total Power Dissipation	$P_D$	$T_C=25^\circ C$	58	W
Total Power Dissipation	$P_D$	$T_A=25^\circ C$	2.4	W
Operating Junction Temperature	$T_J$		-55 to +175	$^\circ C$
Storage Temperature	$T_{STG}$		-55 to +175	$^\circ C$
Single Pulse Avalanche Energy	$E_{AS}$	L=0.1mH, $V_{GS}=10V$ , $R_g=25\Omega$ ,	18	mJ
		L=0.5mH, $V_{GS}=10V$ , $R_g=25\Omega$ ,	38	mJ
ESD Level (HBM)	CLASS 1B			

**•Thermal resistance**

Parameter	Symbol	Min.	Typ.	Max.	Unit
Thermal resistance, junction - case	$R_{thJC}$		-	2.6	°C/W
Thermal resistance, junction-ambient <sup>②</sup>	$R_{thJA}$		-	62	°C/W
Soldering temperature (total time<10s)	Tsold		-	260	°C

**•Electronic Characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	100			V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.3	1.8	2.5	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{GS}=0V, V_{DS}=100V$			1.0	$\mu A$
Gate- Source Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$			100	nA
Static Drain-source On Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=9A$		25	32	m $\Omega$
		$V_{GS}=4.5V, I_D=6A$		32	41	m $\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS}=5V, I_{SD}=10A$		6		S
Diode Forward Voltage	$V_{FSD}$	$V_{GS}=0V, I_{SD}=9A$			1.3	V

**•Dynamic characteristics**

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
Input capacitance	$C_{iss}$	$f=1MHz, V_{DS}=25V$	-	550	-	pF
Output capacitance	$C_{oss}$		-	262	-	
Reverse transfer capacitance	$C_{rss}$		-	28	-	
Gate Resistance	$R_g$	$f=1MHz$	-	1.3		$\Omega$
Total gate charge	$Q_g$	$V_{DD}=15V, I_D=20A, V_{GS}=10V$	-	12	-	nC
	$Q_g(4.5V)$		-	6	-	
Gate - Source charge	$Q_{gs}$		-	3.4	-	
Gate - Drain charge	$Q_{gd}$		-	1.6	-	
Turn-ON Delay time	$t_{D(on)}$		$V_{GS}=10V, V_{DS}=15V, R_G=3.3\Omega, I_D=20A$	-	8	
Turn-ON Rise time	$t_r$	-		6	-	ns
Turn-Off Delay time	$t_{D(off)}$	-		43	-	ns
Turn-Off Fall time	$t_f$	-		32	-	ns
Reverse Recovery Time	$t_{RR}$	$V_{DD}=20V, dI_S/dt=100A/\mu s, I_S=20A$	-	75	-	ns
Reverse Recovery Charge	$Q_{RR}$		-	130	-	nC

Fig.1 Gate-Charge Characteristics

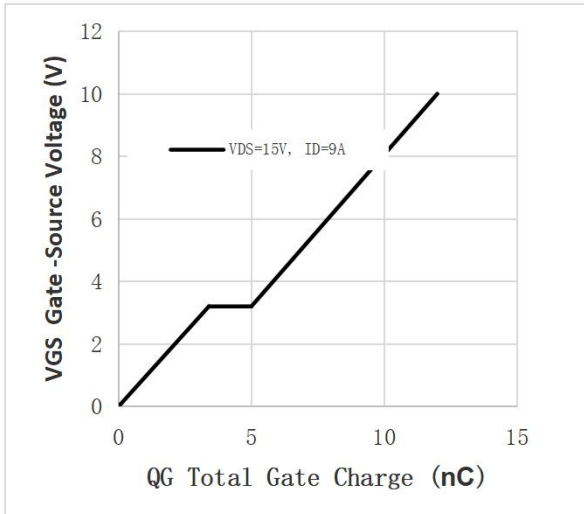


Fig.2 Capacitance Characteristics

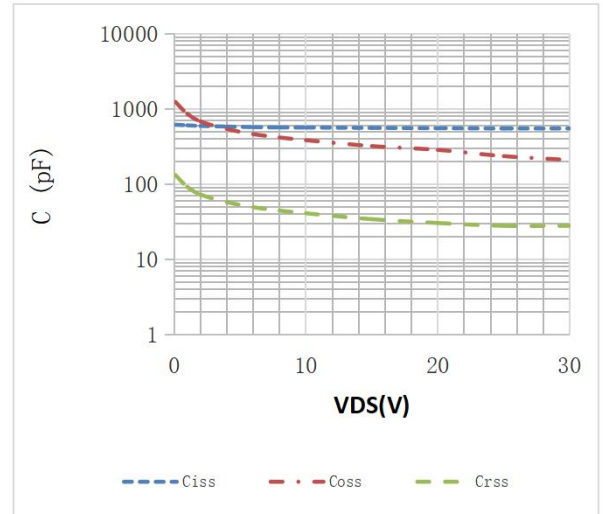


Fig.3 Power Dissipation

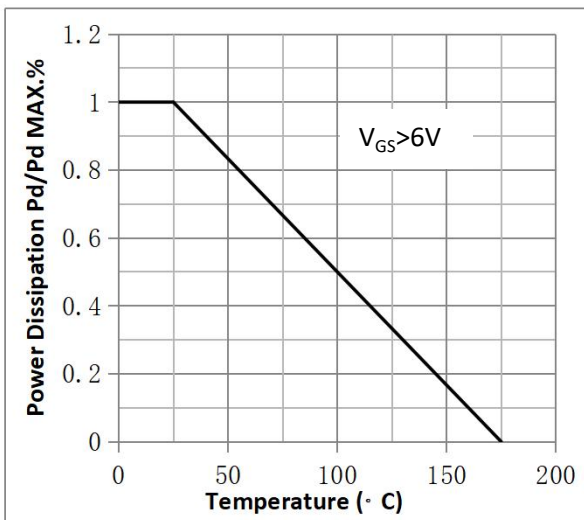


Fig.4 Typical output Characteristics

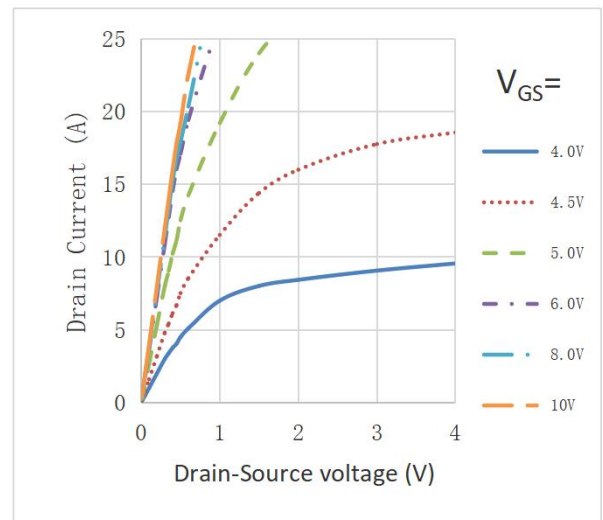


Fig.5 Threshold Voltage V.S Junction Temperature

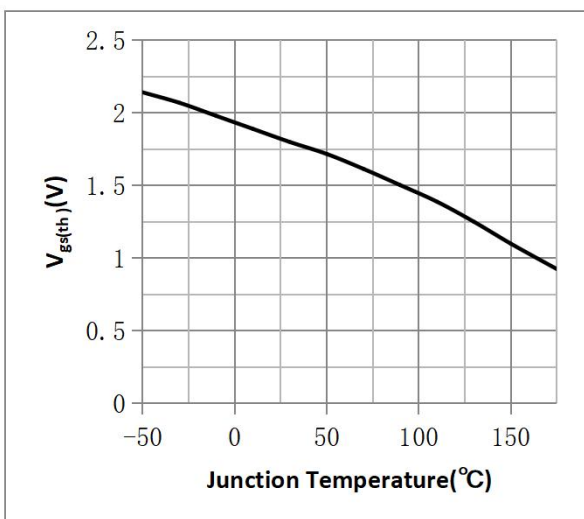


Fig.6 Resistance V.S Drain Current

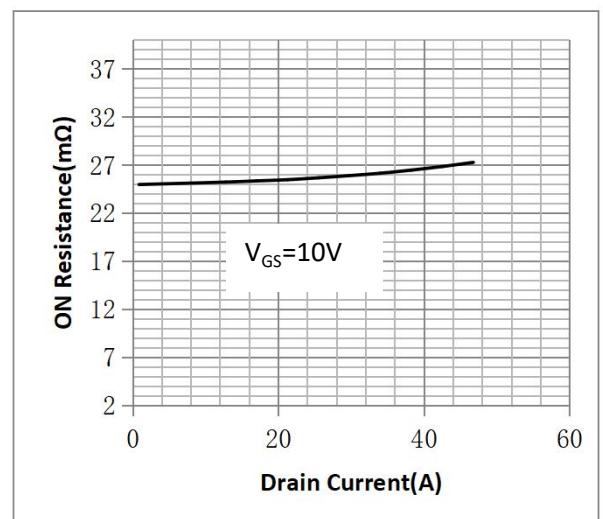


Fig.7 On-Resistance VS Gate Source Voltage

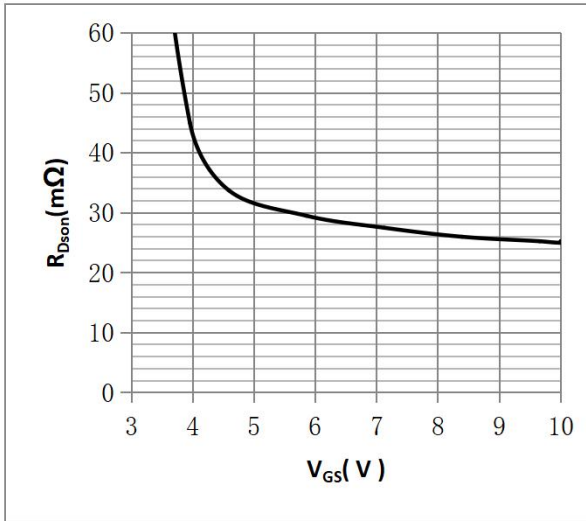


Fig.8 On-Resistance V.S Junction Temperature

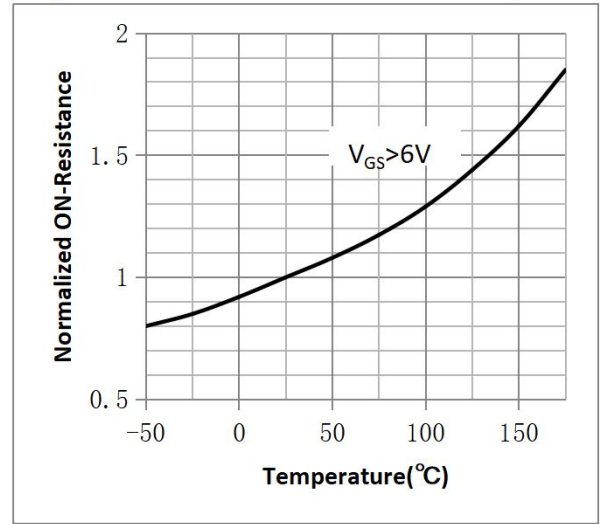


Figure 9. Diode Forward Voltage vs. Current

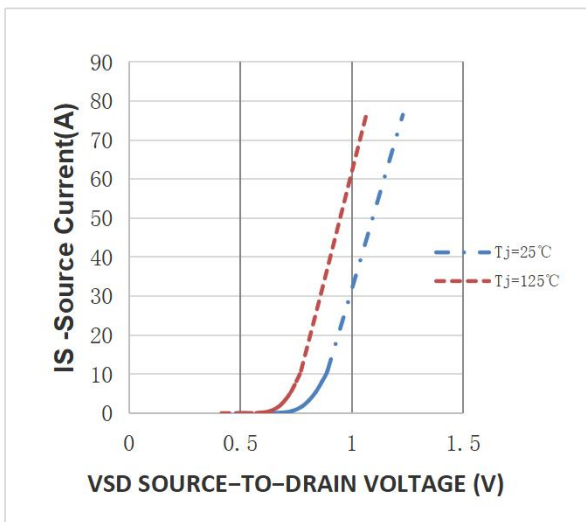


Figure 10. Transfer Characteristics

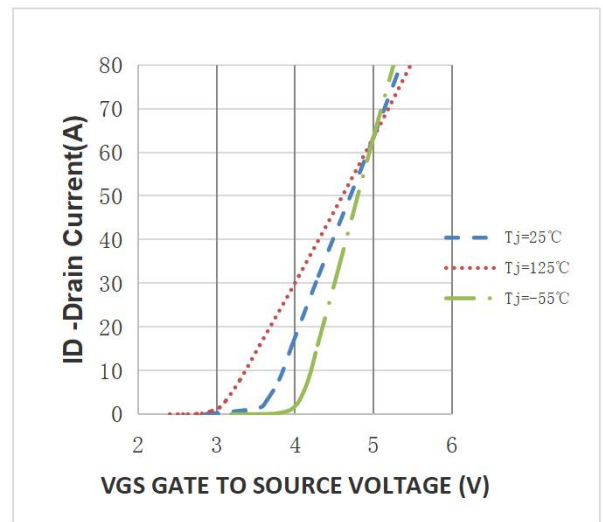


Fig.11 Safe Operating Area

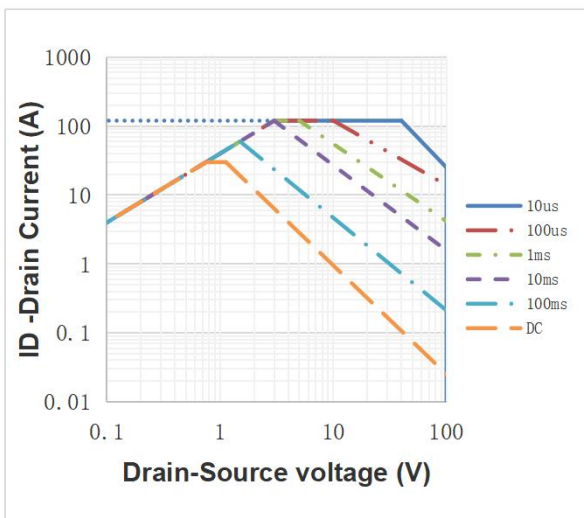
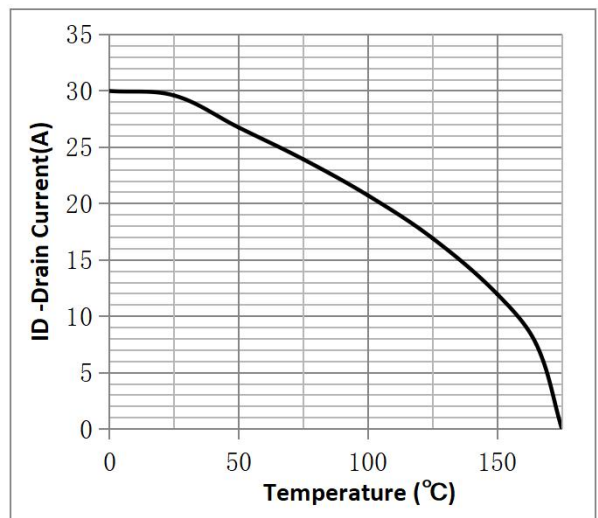
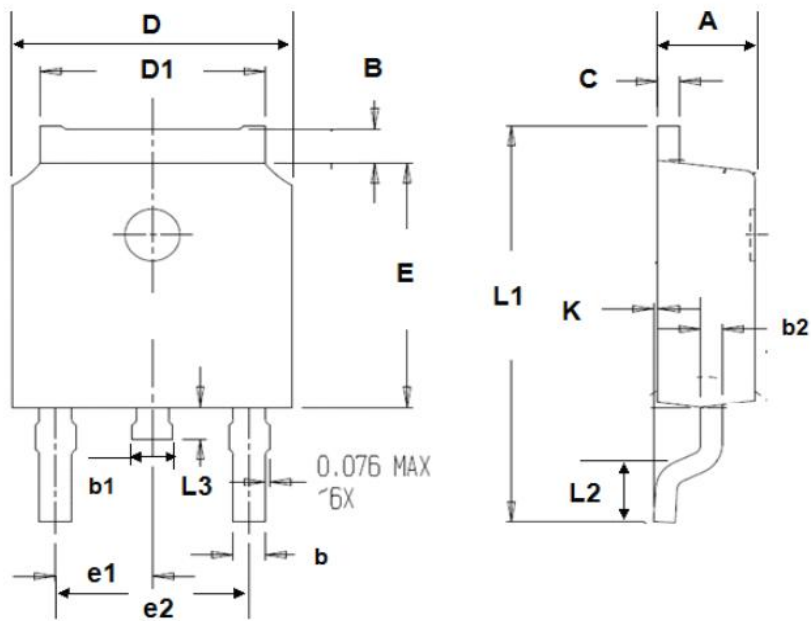


Fig.12 ID vs. Case Temperature<sup>③</sup>



**•TO-252 Package Outline**

SYMBOL	min	max	SYMBOL	min	max
A	2.10	2.50	B	0.85	1.25
b	0.50	0.90	b1	0.50	0.90
b2	0.45	0.70	C	0.45	0.70
D	6.30	6.75	D1	5.10	5.50
E	5.30	6.30	e1	2.24	2.35
L1	9.20	10.60	e2	4.43	4.75
L2	0.90	1.75	L3	0.60	1.10
K	0.00	0.23			



**Note:**

- ① Pulse :  $V_{GS}=+20V/-20V$ , Duty cycle=50%,  $T_j=175^{\circ}C$ ,  $t=1000$  hours; For DC , the following test conditions can be passed:  $V_{GS}=+20V/-10V$ ,  $T_j=175^{\circ}C$ ,  $t=1000$  hours;
- ② Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate;
- ③ Practically the current will be limited by PCB, thermal design and operating temperature.  
 $V_{GS}=10V$ .

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## Revision History

Version	Date	Change
A	2021.11.10	
B	2022.5.7	1.Add note 1
C	2022.9.20	modify 3.Add It is suitable for automotive application.4.Add Dynamic